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ALD/MLD processes for Mn and Co based hybrid thin films

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Here we report the growth of novel hybrid transition metal-organic thin-film materials consisting of manganese or cobalt as the metal component and terephthalate as the rigid organic backbone. The hybrid thin films are deposited by the currently strongly emerging atomic/molecular layer deposition (ALD/MLD) technique using the combination of metal β-diketoneate, i.e. Mn(thd)$_2$, Co(acac)$_2$, or Co(thd)$_2$, and terephthalic acid (1,4-benzenedicarboxylic acid) as precursors. All the processes yield homogeneous and notably smooth amorphous metal-terephthalate hybrid thin films with growth rates of 1–2 Å/cycle. The films are stable towards humidity and withstand high temperatures up to 300 or 400 °C under oxidative or reductive atmosphere, respectively. The films are characterized with XRR, AFM, GIXRD, XPS and FTIR techniques.

Introduction

Our future high-tech applications are increasingly based on (ultra)thin films with atomic-level control of the film thickness and composition over different structurally challenging and/or large-area surfaces. So far the only deposition technique meeting the criteria of industrial feasibility for such state-of-the-art thin films is the atomic layer deposition (ALD) method; it is based on self-limiting gas-to-surface reactions of mutually separated gas pulses of two (or more) different precursors and enables the fabrication of high-quality conformal coatings of various simple inorganic compounds for e.g. advanced semiconductor, catalyst, sensor and barrier-layer applications.

Currently there is a strong strive to extend the ALD technique to increasingly complex compounds and material compositions to better answer to the future demands. This includes not only various ternary and quaternary inorganic compounds, but also inorganic-organic hybrids realized through the combined ALD/MLD technique; here the MLD (molecular layer deposition) method first developed for purely organic materials is based on organic precursors only and yields through sequential gas-surface reactions organic polymeric thin films in a molecular layer-by-layer manner like the original ALD method for the inorganics. While there are not much more than a handful of publications on purely organic MLD films, the interest towards developing new ALD/MLD processes for the inorganic-organic hybrid materials is rapidly growing. Most of the early ALD/MLD works concern very few metal constituents (mainly Al, Zn, Ti and Zr) but in the most recent works the technique has been successfully extended to some 3d, 4f and alkali metal based hybrid thin films with interesting luminescence and electrochemical properties. Hybrid thin-film materials based on 3d transition elements with partially-filled d orbitals would be attractive due to their potential to show e.g. exciting electrical, magnetic and catalytic properties; in particular, based on the experiences from conventional inorganic compounds, manganese and cobalt would be among the most interesting 3d metal constituents.

In conventional ALD for the inorganics, β-diketoneate complexes based on the 2,2,6,6-tetramethyl-3,5-heptanediene(thd) and acetylacetonate(acac) ligands are commonly employed as precursors for e.g. manganese and cobalt, and have already been successfully utilized even in some ternary and quaternary oxide processes. Even though the β-diketoneate precursors work very well in ordinary ALD processes, they have been little utilized in the hybrid ALD/MLD processes since they do not react with the typical alcohol-based MLD precursors. Only very recently when carboxylic acids were employed as organic precursors the first β-diketionate based ALD/MLD processes were developed for Cu(thd)$_2$, Li(thd)$_2$, Zn(CH$_2$CO$_2$)$_2$ and Eu(thd)$_3$. In these depositions the organic precursor was aromatic with a rigid benzene ring structure which is beneficial for the film growth; the aromaticity is also believed to help to preserve the electrical properties of the inorganic constituent, giving the resilient hybrid materials exciting features in electronics. In literary, linear carboxylic acids have been employed as well to fabricate e.g. iron and aluminium based hybrid materials.

In this paper, we introduce novel ALD/MLD processes for manganese and cobalt based hybrid thin films using Mn(thd)$_2$, Co(acac)$_2$ and Co(thd)$_2$ as the metal precursors and benzene-1,4-dicarboxylic acid (1,4-BDC) or so-called terephthalic acid (TPA) as the organic precursor, see Fig. 1. We will moreover show that the film growth rate is essentially higher for the process in which the cation in the metal precursor is divalent, i.e. with Co(thd)$_2$, presumably due to the less severe steric hindrance.

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Results and discussion

We first investigated the saturation behaviour of the surface reactions for our Mn(thd)$_3$–TPA, Co(acac)$_3$–TPA and Co(thd)$_2$–TPA processes by changing the precursor pulse lengths one at the time in each process and monitoring the resultant film growth-per-cycle (GPC) value based on XRR data after 400 deposition cycles, see Fig. 2. In these experiments the deposition temperature was set to 200°C for all the three processes, and the precursor pulse length was fixed at 2 s for the metal precursor when the TPA pulse length was varied, and at 10 s for the TPA pulse when the metal precursor pulse length was varied. From Fig. 2, the surface reactions indeed saturate for relatively short pulse lengths, even though the precursor sublimation temperatures applied here are relatively low, i.e. 105°C (c.f. 133°C$^{18}$) for Mn(thd)$_3$, 128°C (c.f. 180°C$^{29}$) for Co(acac)$_3$, 100°C (c.f. 110°C$^{30}$) for Co(thd)$_2$ and 180°C (c.f. 220°C$^{24}$) for TPA. We like to emphasize that the use of the lower sublimation temperatures is advantageous as it allows us to also use lower deposition temperatures and thereby employ the processes for e.g. temperature-sensitive substrates. For the rest of the experiments the pulse and purge lengths were fixed as follows: 5 s metal precursor + 2 s N$_2$ purge + 10 s TPA + 20 s N$_2$ purge.

Then the temperature window for the "ideal ALD/MLD-type" growth was searched for within 160–280°C by monitoring the values for GPC, film density and film roughness (all determined from XRR data) as a function of the deposition temperature, see Fig. 3 left panel. Note that the relevant deposition temperature range was limited by the TPA sublimation temperature in the low temperature side (180°C) and the emergence of CVD-type growth accompanied with desorption of organic material in the high temperature side (280°C). Temperatures lower than the sublimation temperature of TPA were however tested as well with the anticipation that the lower deposition temperature might promote the formation of crystalline phases as was recently seen in the case of our Cu(thd)$_2$–TPA process.$^{14}$ By monitoring solely the growth rate, it is not straightforward to claim any optimal deposition temperature window for any of the three processes investigated. However, as the density and roughness values remain essentially constant in the temperature range of 200–220°C, 170–260°C and 180–260°C for the Mn(thd)$_3$–TPA, Co(acac)$_3$–TPA and Co(thd)$_2$–TPA processes, respectively, and...
the films’ surfaces remain appreciably smooth (with a roughness value as low as 0.2 nm for ca. 30 nm thick films), we decided to fix the deposition temperature at 200°C for the rest of the experiments. At this deposition temperature the essentially ideal ALD/MLD behaviour, i.e. linear dependency of the film thickness on the number of ALD/MLD cycles, is seen for all the three processes as demonstrated in Fig. 3, right panel.

In Fig. 4 we display the XRR patterns for a series of films with different thicknesses (for all the three processes) where the thickest films are on the top and the thinnest on the bottom of the figure; the patterns correspond to the thickness data shown in the right panel of Fig. 3. The slow overall decay rates of intensity and oscillations indicate that the films are appreciably homogeneous and smooth on their surfaces; it should be noted that care was taken to keep the substrates always of the same size as the size somewhat affects the initial decay rate. Then the distance between two amplitudes in the XRR pattern corresponds to the film thickness. As seen for the thickest film from the Co(acac)$_{3}$-TPA process, secondary oscillations arise, indicating a non-perfect deposition process of thicker films with a formation of a thin secondary layer. Apparently the film quality is better for the two thd-based processes than for the Co(acac)$_{3}$-TPA-process.

This is in line with the fact that typically the thd-precursors have been favoured over the acac-precursors in the conventional ALD technology despite their higher prices, which is probably due to the better overall reactivity and ligand detachment properties.

Since we recently found a narrow deposition temperature range for our Cu(thd)$_{2}$-TPA process$^{14}$ where the process yielded crystalline metal-organic framework (MOF) films, we systematically checked the possible crystallinity of the present samples as well by GIXRD measurements; however, all the present thin films were found to be amorphous, even though a slight density drop was seen for the Mn-TP films deposited at lower temperatures, similarly to the case with the Cu-TP films.

Fig. 4 XRR patterns for films with different thicknesses deposited with the three ALD/MLD processes, Mn(thd)$_{3}$-TPA (A), Co(acac)$_{3}$-TPA (B) and Co(thd)$_{2}$-TPA (C); the order is in each case from the thinnest (bottom) to the thickest (top).

Fig. 5 FTIR spectra for films deposited with the three ALD/MLD processes, Mn(thd)$_{3}$-TPA (A), Co(acac)$_{3}$-TPA (B), Co(thd)$_{2}$-TPA (C) and a spectrum for the TPA precursor (+KBr) for reference.
For bulk samples, crystalline terephthalate structures have been reported for divalent Co(II), but not for trivalent cations.\textsuperscript{33}

Fourier-transform infrared spectroscopy was employed to verify the organic constituent in the films and its coordination to the metal; representative spectra are shown in Fig. 5. As described by e.g. Klepper et al.,\textsuperscript{34} the type of the carboxylate coordination can be evaluated from the symmetric ($\nu_s$) and asymmetric ($\nu_{as}$) stretches of the COO group. The peaks found for all the precursor combinations in the signature wave number area are at ca. 1615 cm$^{-1}$ (shoulder), 1575 cm$^{-1}$ (shoulder), 1555 cm$^{-1}$ (s), 1515 cm$^{-1}$ (m), 1425 cm$^{-1}$ (shoulder), 1405 cm$^{-1}$ (shoulder) and 1390 cm$^{-1}$ (s). The peaks at 1390 cm$^{-1}$ and 1575-1550 cm$^{-1}$ correspond to $\Delta (\nu_{s}-\nu_{as})$ of ca. 160–185 cm$^{-1}$, thus the bonding scheme is dominantly of the bridging type.\textsuperscript{34}

The wide peaks indicate most likely the amorphous nature of the films with slightly varying surroundings for the COO group. The FTIR spectra do not show any peaks in the 2000–3200 cm$^{-1}$ area, which would correspond to adsorbed H$_2$O, unreacted carboxylic acid groups or carbohydrate-based impurities.

Presented in Fig. 6, the quality of the amorphous films was further evaluated using atomic force microscopy (AFM). The root-mean-square roughness values were 0.2 nm (total thickness 32.6 nm), 0.2 nm (42.1 nm) and 0.2 nm (37.4 nm) for the Mn(thd)$_3$–TPA, Co(acac)$_2$–TPA and Co(thd)$_2$–TPA processes, respectively, well agreeing with the roughness values derived from the XRR data (±0.1 nm). Also remarkably, the lack of any high features for any of the films indicates that the surfaces are essentially free from surface contamination by adsorbed particles. The samples were stored under 30% RH atmosphere for 60 days prior to the AFM measurements.

To further investigate the stability of our new Mn- and Co-based hybrid thin films we exposed the films for up to 40 days to precisely controlled atmosphere of ca. 30% relative humidity. There were no notable visual changes, and the thickness changes of the films were within 1 nm, which is a typical error margin for XRR thickness measurements. The inertness of the films against humidity arise most likely from the completely coordinated amorphous structure, and due to the reduction of gas absorption through the sealed well-stacked film. Then the thermal stability of the films was studied by heating them in an RTA oven for 15 minutes under different atmospheres. The films remained intact up to ca. 300°C in O$_2$ and up to ca. 400°C in Ar.

Finally we discuss the film growth rates for the three processes, Mn(thd)$_3$–TPA, Co(acac)$_2$–TPA and Co(thd)$_2$–TPA; in the first two processes the transition metal (Mn or Co) in the inorganic precursor is trivalent, while being divalent in the last process. The GPC values for the processes where the metal precursor is trivalent were ca. 1.0–1.2 Å/cycle, while being clearly higher. i.e. 1.5 Å/cycle, for the Co(thd)$_2$–TPA process where cobalt is divalent. The growth rate seems to correlate with the area taken by the precursor ligands which remains after the precursor has attached to the surface group. Similar observations/conclusions have been reported by e.g. Ylilammi et al.,\textsuperscript{35} and Lie et al.,\textsuperscript{21} and also in some other previous studies.\textsuperscript{26}

Assuming the precursors detach one of their ligands when reacting with the surface, the Mn(thd)$_3$ group (corresponding to the lowest GPC value) is by six methyl groups larger than the Co(acac)$_2$ group, and as they both take notably more space compared to the Co(thd)$_2$ group corresponding to the highest GPC value, we may indeed conclude that for the present ALD/MLD processes the growth rate inversely depends on the surface area required by the precursor ligands. Very similar correspondence was seen for example for the quaternary oxide process among the La(thd)$_3$, Sr(thd)$_2$ and Co(acac)$_3$ precursors.\textsuperscript{22}

The situation is illustrated as a two-dimensional model for simplicity in Fig. 7 where in the left panel, the ligands from a divalent cation precursor have clearly more space to promote further growth of the film (the space occupied by an individual precursor illustrated with a green box) compared to the right panel case where the ligands from a trivalent cation precursor...
block some of the surface sites and thus the film growth is essentially less than a monolayer per cycle.

![Schematic illustration (in two-dimension) of the space occupied by bulky cone-shaped ligands in precursors of divalent (left) and trivalent (right) metal cations.](Figure 7)

![Co 2p XPS spectrum for a Co-TP hybrid thin film deposited from Co(thd)2 and TPA precursors.](Figure 8)

Another interesting question related to the different oxidation states of the metal species in our precursors concerns weather the divalent state of cobalt in the Co(thd)2 precursor is maintained upon the ALD/MLD process; we carried out XPS measurements to clarify this. The XPS spectrum shown in Fig. 8 for a resultant film from the Co(thd)2–TPA process reveals the Co 2p_{3/2} and 2p_{1/2} peaks at ca. 785.5 and 802.2 eV, respectively, followed by prominent satellite peaks on the higher-energy sides of the main peaks. The presence of intense satellite peaks is an indication of the divalent state of cobalt, and hence we can conclude that the divalent state of cobalt in the Co(thd)2 precursor is at least partly maintained upon the ALD/MLD process. Additionally, our XPS measurements confirmed (the wider-energy-range spectrum not shown here) that our hybrid films are free from any significant impurities, the only impurity seen being 0.4 % nitrogen, probably adsorbed from the air.

**Experimental**

Thin films of Mn-TP and Co-TP were successfully grown in a commercial ALD reactor (F-120, ASM Microchemistry Ltd.) using Mn(thd)3 (thd: 2,2,6,6-tetramethyl-3,5-heptanedi9e), Co(acac)2 (acac: acetylacetone) and Co(thd)2 as metal precursors, and benzene-1,4-dicarboxylic acid (1,4-BDC or TPA) as the organic precursor. The Co(thd)2 and Mn(thd)3 precursors were prepared in-house by synthesis method described elsewhere, while commercial sources were used for Co(acac)3 (Sigma, CAS: 21679-46-9, 99.99%) and terephthalic acid (Tokyo Chemical Industry CO., Ltd, CAS: 100-21-0). The sublimation temperatures of the solid precursors were fixed at 105, 128, 100 and 180 °C for Mn(thd)3, Co(acac)3, Co(thd)2 and TPA, respectively, based on our preliminary data from thermogravimetric analysis (TG; Perkin-Elmer TGA 7) and sublimation rates in the F-120 reactor. Nitrogen (99.999 %, 300 sccm, Schmidlin UHPN 3000N generator) was used as the carrier and purge gas in the depositions with the background pressure of ca. 2-3 mbar (1.5–2 Torr). All the depositions were performed on silicon (p-type, Si(100), Okmetic Ltd.) substrates.

Grazing incidence X-ray diffraction (GIKRD; PANalytical model X’Pert PRO diffractometer, Cu Kα radiation) was used to investigate the possible crystallinity of the films measured at grazing incidence angle of 0.5° from 2θ = 5–70°, and X-ray reflectivity (XRR) measurements using the same equipment to determine the film thickness, density and roughness. The film thickness values given are averages of the values calculated using the direct calculation and the Fourier methods. The film roughnesses were further analysed with atomic force microscopy (AFM; Veeco Dimension 5000) with 1.0 - 1.5 Hz scan speed in tapping mode. The organic component was verified and the coordination type investigated using Fourier transform infrared spectroscopy (FTIR; Nicolet Magna-IR Spectrometer 750), where the average of 32 scans with 4 cm⁻¹ resolution was applied for each sample. The film resiliency was proved using a rapid thermal annealing oven (RTA; PEO 601, ATV Technologie GmbH) in 5.0 O₂ and 5.0 Ar gas flows of ca. 200 l h⁻¹ with a hold-time of 15 minutes in the target temperature. The heating and cooling rates were set to 20 and 25 °C min⁻¹, respectively. The valence of cobalt and the elemental composition in the film was determined using x-ray photoelectron spectroscopy (XPS; Kratos Analytical).

**Conclusions**

We have here extended the ALD/MLD technology to cover new transition metal components, namely manganese and cobalt, as we successfully developed novel deposition processes for hybrid inorganic-organic Mn-TP and Co-TP thin films. The fact that transition metals in general have many important features in electronics and catalysis due to their partially filled 3d orbitals makes the newly developed hybrid films potential candidates for a variety of future applications.

For the Co-TP films, two precursors were tested; the divalent Co(thd)2 precursor yielded smoother films with a somewhat higher growth-per-cycle rate of 1.5 Å/cycle than the
trivalent Co(acac)₂ precursor. All the three processes, Mn(thd)₂–TPA, Co(acac)₂–TPA and Co(thd)₂–TPA, yielded homogeneous and smooth amorphous films within the deposition temperature range of 200–260 °C. Moreover the films were found to be appreciably stable and proven to endure over moist, oxidizing and reductive conditions. The terephthalate as the organic constituent in the hybrid films is highly interesting due to its high reactivity even with β-diketonate metal precursors, which previously have been unaccessible for hybrid ALD/MLD depositions, thus considerably expanding the number of possible hybrid precursors. We foresee that other dicarboxylic acids could be interesting candidate precursors as well to be combined with transition metal β-diketonate (e.g. thd or acac) based precursors for novel ALD/MLD processes to further expand the variety of ALD/MLD chemistries and resultant hybrid film properties.

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Notes and references